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3 V SUPER MINIMOLD L-BAND SI MMIC DOWNCONVERTER

UPC2756TB

FEATURES

CEL

- HIGH DENSITY SURFACE MOUNTING: 6 Pin Super Minimold or SOT-363 package
- WIDE BAND OPERATION: RF = 0.1 to 2.0 GHz IF = 10 to 300 MHz
- ON BOARD OSCILLATOR
- **SUPPLY VOLTAGE:** Vcc = 2.7 TO 3.3 V

DESCRIPTION

NEC's UPC2756TB is a silicon MMIC integrated circuit manufactured using the NESAT III process. The device consists of a double balance mixer, an IF amplifier and a built-in LO. this device is suitable as a L-BAND downconverter for the receiver stage of wireless systems. The UPC2756TB is pin compatible and has comparable performance as the larger UPC2756T, so it is suitable for use as a replacement to help reduce system size. The IC housed in a 6 pin super minimold or SOT-363 package.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

ELECTRICAL CHARACTERISTICS (TA = 25° C, Vcc = 3 V, ZL = Zs = 50Ω)

	PART NUMBER PACKAGE OUTLINE	UPC2756TB \$06			
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	ТҮР	MAX
Icc	Circuit Current (no signal)	mA	3.5	6.0	8.0
fRF	RF Frequency Response (3 dB down from the gain at fRF = 900 MHz, fIF = 150 MHz)	GHz	0.1		2.0
fiF	IF Frequency Response (3 dB down from the gain at fRF = 900 MHz, fIF = 150 MHz)	MHz	10	300	
CG	$ \begin{array}{ll} \mbox{Conversion Gain}^1 & \mbox{f}_{FF} = 900 \mbox{ MHz}, \mbox{f}_{FF} = 150 \mbox{ MHz} \\ \mbox{f}_{FF} = 1.6 \mbox{ GHz}, \mbox{f}_{FF} = 20 \mbox{ MHz} \end{array} $	dB dB	11 11	14 14	17 17
NF	Noise Figure fRF = 900 MHz, fIF = 150 MHz fRF = 1.6 GHz, fIF = 20 MHz	dB dB		10 13	13 16
PSAT	Saturated Output Power ² free = 900 MHz, fire = 150 MHz free = 1.6 GHz, fire = 20 MHz	dBm dBm	-11 -15	-8 -12	
OIP3	SSB Output 3rd Order Intercept Point fRF = 0.8~2.0 GHz, fIF = 100 MHz	dBm		+4	
ISO	LO Leakage, fLO = 0.8 ~2.0 GHz at RF pin at IF pin	dBm dBm		-35 -23	
PN	Phase Noise ³ , fosc = 1.9 GHz	dBc/Hz		-68	
Rth (J-A)	Thermal Resistance (Junction to Ambient) Mounted on a 50 x 50 x 1.6 mm epoxy glass PWB	°C/W			325

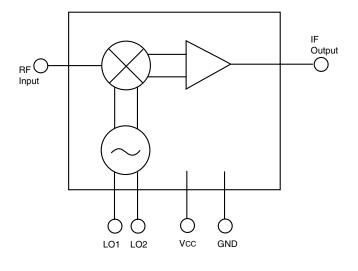
Notes:

1. PRF = -40 dBm.

2. PRF = -10 dBm.

3. See Application Circuit.

INTERNAL BLOCK DIAGRAM



California Eastern Laboratories

ABSOLUTE MAXIMUM RATINGS¹ (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	V	5.5
Рт	Total Power Dissipation ²	mW	200
Тор	Operating Temperature	°C	-40 to +85
Tstg	Storage Temperature	°C	-55 to +150

Notes:

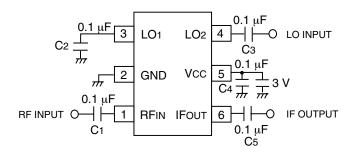
1. Operation in excess of any one of these parameters may result in permanent damage.

2. Mounted on a 50 x 50 x 1.6 mm epoxy glass PWB (TA = $+85^{\circ}$ C).

RECOMMENDED OPERATING CONDITIONS

SYMBOLS	PARAMETERS	UNITS	MIN	ТҮР	MAX
Vcc	Supply Voltage	V	2.7	3.0	3.3
Тор	Operating Temperature	°C	-40	+25	+85

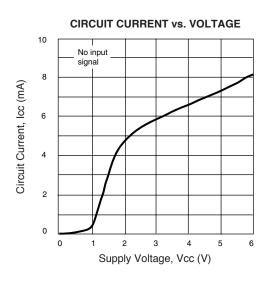
TEST CIRCUIT



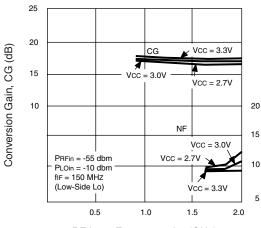
PIN FUNCTIONS

Pin No.	Symbol	Applied Voltage (V)	Pin Voltage (V)	Description	Internal Equivalent Circuit
1	RFin	-	1.2	Signal input pin to double balancec mixer. This pin must be coupled to the signal source with a blocking capacitor.	
2	GND	0	_	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible.	
3	LO1	_	1.2	These pins are both the base- collectors of a differential amplifier configured to oscillate when equipped with an external tank resonator circuit. Each pin must be coupled to the tank circuit with a blocking capacitor. In the case of an external LO source, bypass the unused pin with a capacitor to ground.	
4	LO2	-	1.2		<i></i>
5	Vcc	2.7 to 3.3	-	Power supply pin. This pin should be externally equipped with a bypass capacitor to minimize ground impedance.	
6	IFout	-	1.7	Output of single-ended push-pull IF buffer amplifier. This is an emitter-follower output with low impedance. This pin must be coupled to the next stage with a blocking capacitor.	

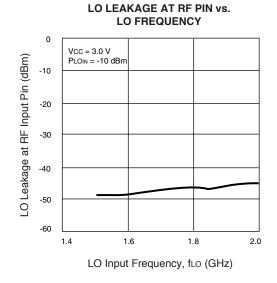
TYPICAL PERFORMANCE CURVES (TA = 25°C)

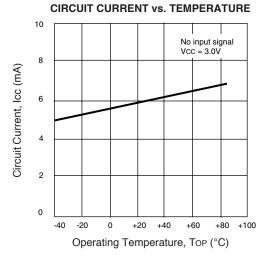


CONVERSION GAIN AND NOISE FIGURE vs. RF INPUT FREQUENCY

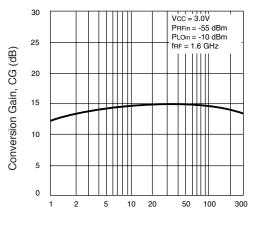


RF Input Frequency, fRF (GHz)





CONVERSION GAIN vs. IF OUTPUT FREQUENCY



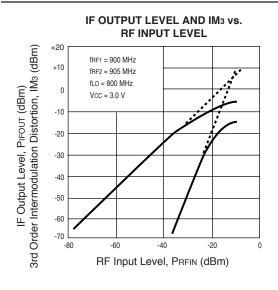
IF Output Frequency, fiF (GHz)

LO LEAKAGE AT IF PIN vs. LO FREQUENCY 0 VCC = 3.0V PLOIN = -10 dBm -10 -20 -30 -40 -50 -60 0.8 1.0 1.2 1.4 1.6

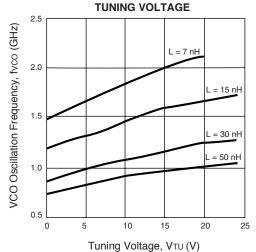
LO Leakage at IF Output Pin (dBm)

LO Input Frequency (GHz)

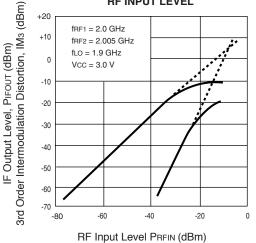
TYPICAL PERFORMANCE CURVES (TA = 25°C)



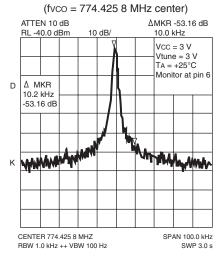
VCO OSCILLATION FREQUENCY vs.

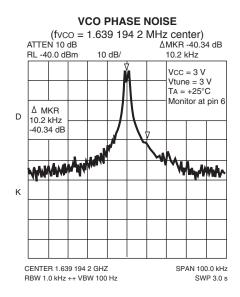


IF OUTPUT LEVEL AND IM₃ vs. RF INPUT LEVEL

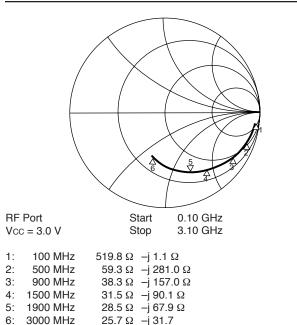


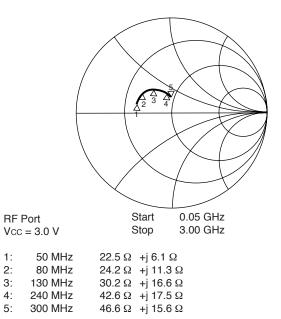
VCO PHASE NOISE



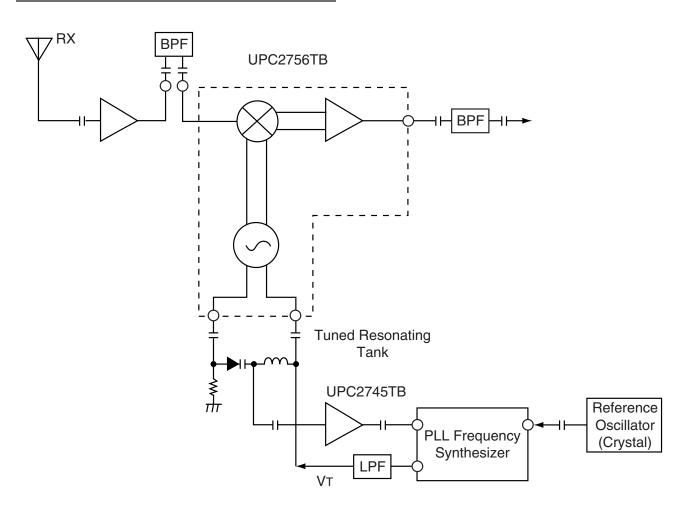


TYPICAL SCATTERING PARAMETERS



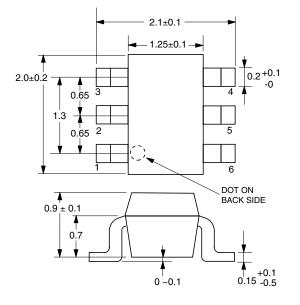


SYSTEM APPLICATION EXAMPLE

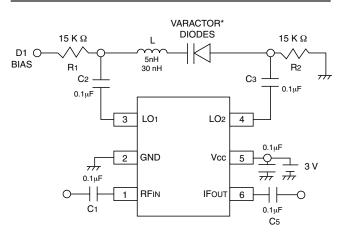


OUTLINE DIMENSIONS (Units in mm)

PACKAGE OUTLINE S06



APPLICATION CIRCUIT EXAMPLE



* Recommended Varactor Diodes:

Alpha SMV1204-4, Toshiba 1SV186 or equivalent

Life Support Applications

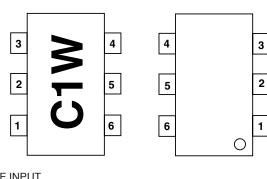
These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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LEAD CONNECTIONS

(Top View)

(Bottom View)



1. RF INPUT 2. GND 3. LO₁ 4. LO₂ 5. Vcc 6. IF OUTPUT

ORDERING INFORMATION

PART NUMBER	QTY			
UPC2756TB-E3-A	3K/Reel			

Note:

Embossed Tape, 8 mm wide, Pins 1, 2, 3 are in tape pull-out direction.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	valent Chromium < 1000 PPM Not Detected		etected	
РВВ	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

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